GDT
Gas Discharge Tube

SPI Series

Description

Gas Discharge Tube (GDT) is a single-gap or multi-gap switching overvoltage protection device. Under normal circumstances, the GDT is in a high-impedance state; when suffer a surge, the GDT will change from a high-impedance state to a low-impedance state, and release the surge energy to the ground, reducing the residual voltage of the circuit, thereby protecting the equipment circuit or protect the human body from the hazards of transient overvoltage. GDT is formed by high-temperature sealing of metal electrodes, metallized ceramics, inert gas or other mixed gases.

Features

- Fast Response
- Stable Performance Over Surface Life
- High Current Rating
- Low Capacitance
- High Insulation Resistance
- RoHS & REACH Compliant

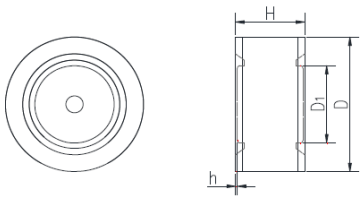
Agency Information

Agency Symbol	Standards	The File No. and certification No. obtained by SETsafe | SETfuse
	UL1449	E322662
c	UL1449	E322662

Applications

- Surge Protective Device
- Telecom Equipment
- New Energy

Dimensions (mm)



D	D_1	H	h
Φ16.0 ± 0.5	Φ9.0	8.0 ± 0.5	0.2

Notes: May increase each kind of connect mode according to the customer different demand.

Part Numbering System

SP I 601 D - XX

- Lead Type
  A: No Lead, B: Single Lead,
  C: With Lead, 0、1、2.....
  With Different Lead)
- Nominal Discharge Current
  (H: 20 kA, D: 40 kA)
- D.C. Spark-over Voltage (100 V/s)
  (601: 60×10^1)
- Product Structure:
  Φ 16.0 × 8.0 mm
- Series: SP

Reminder:
Part numbering system in the datasheet is only for selecting correct parameter and product features. Before placing order, please contact us for specifications and use the part number and product code in the specifications to place order to ensure the part is correct. Product code is the unique indentification.

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Specifications

Model			SPI351D - XX	SPI601D - XX	SPI801D - XX	SPI152H - XX	SPI252H - XX	Units
Category			II	I&II	I&II	II	II	
Application			N - PE	N - PE	N - PE	N - PE	N - PE	
Nominal D.C. Spark-over Voltage (100 V/s)			350	600	800	1500	2500	V
D.C. Spark-over Voltage (100 V/s)			280 ~ 420	480 ~ 720	640 ~ 960	1200 ~ 1800	2000 ~ 3000	V
Impulse Spark-over Voltage @1 kV/μs			< 900	< 1200	< 1600	< 2800	< 4500	V
GB/T18802.311								
Nominal Impulse Discharge Current @8/20 μs I_n			40	40	40	20	20	kA
Maximum Impulse Discharge Current @8/20 μs I_{max}			80	80	80	40	40	kA
ClassI/II (Comply with IEC61643-11)								
Max Continuous Operating Voltage *Uc* 50/60 Hz			110	255	275	320	440	Vrms
Follow Current Cut-off Ability AC 50/60 Hz I_f			100	100	100	100	100	Arms
Nominal Discharge Current @8/20 μs I_n			40	40	40	20	20	kA
Maximum Discharge Current @8/20 μs I_{max}			80	80	80	40	40	kA
Impulse Discharge Current @10/350 μs			15	15	15	8	6	kA
Insulation Resistance (100 VDC)			> 1000	> 1000	> 1000	> 1000	> 1000	MΩ
Capacitance at 100 kHz			< 8	< 8	< 8	< 8	< 8	pF
Agency Approvals	UL1449		○	●	●	○	●	
	UL1449		○	●	●	○	●	
	TUV		○	○	○	○	○	

Note:

1. The above parameters based on ITU-T K12 & IEC61643.311、IEC61643.11 standards.
2. Connect mode according to the customer different demand.
3. "●" means GDT has gained the certification, "○" means GDT is no certification.
4. Operating Temperature -40 °C ~ +125 °C .

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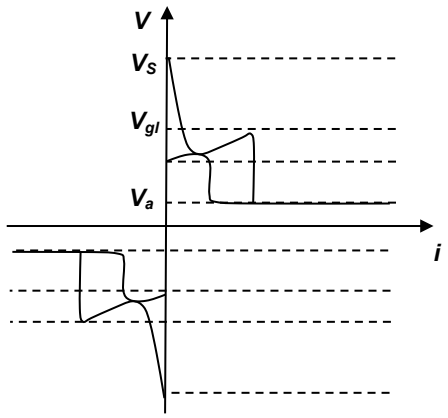
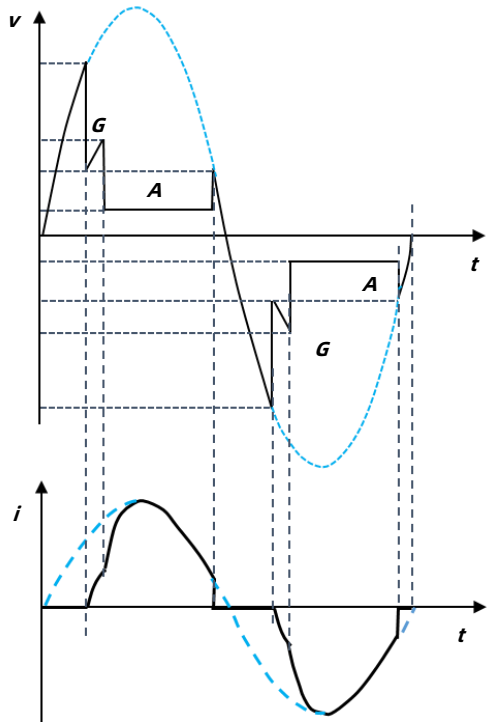
Electrical Characteristics



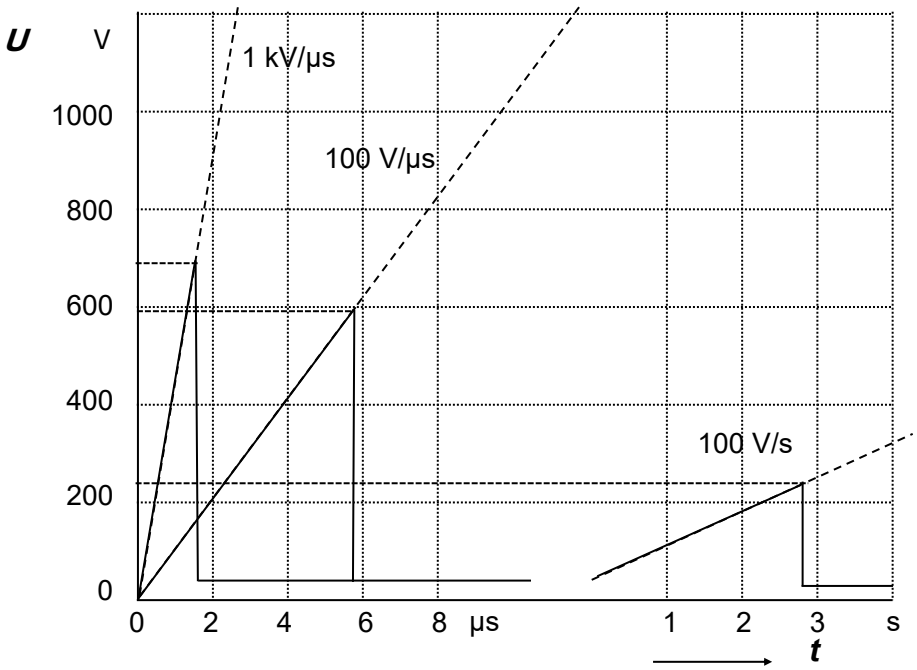
Relationship between Current and Voltage



Time Variation Patterns of Voltage and Current

V_s : Spark-over Voltage
Vgl: Glow Voltage
Va : Arc Voltage
G : Glow Mode
A : Arc Mode

Reference Curve for Spark-over Voltage (Refer to 230 VDC)



Dynamic Response
Impulse Spark-over Voltage
(100 V/μs,1 kV/μs)

Static Response
D.C. Spark-over Voltage (100 V/s)

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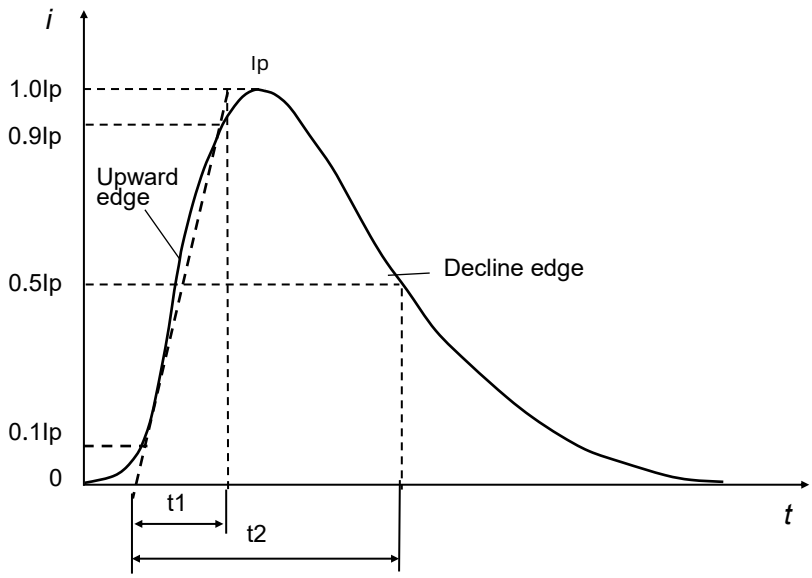
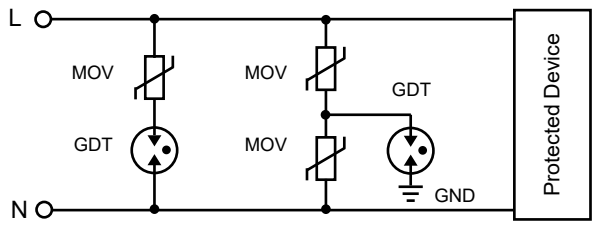
Curve for Impulse Discharge Current (For Reference Only)



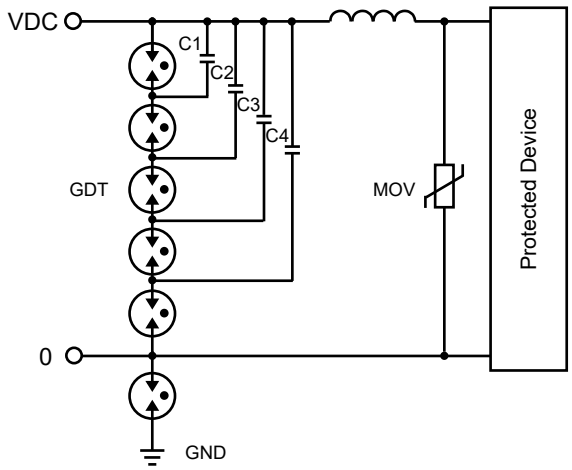
I_p: Peak current
t_1: Rise time in μs
t_2: Delay time to half value in μs

Application Example (For Reference Only)

AC Power Protection



DC Power Protection



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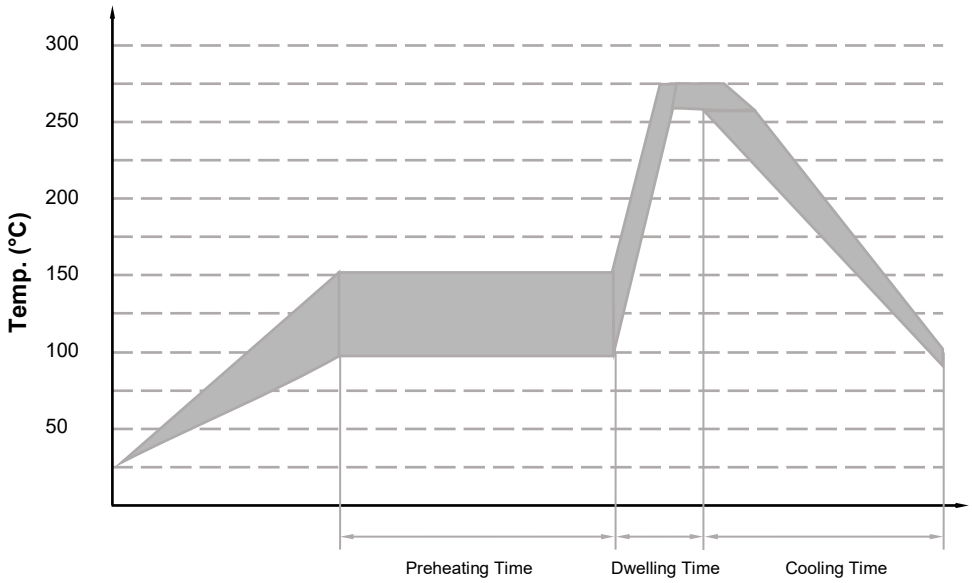
Recommended Hand-soldering Parameters (For Reference Only)

Items	Condition
Soldering Iron Temperature	350 °C (Max.)
Soldering Time	4 s (Max.)
Space between soldering point and product body	According to the guidance method

Wave Soldering Parameters (For Reference Only)



Item	Temp. (°C)	Time (s)
Preheating	90 to 150	< 150
Dwelling	255 to 280	3 to 10

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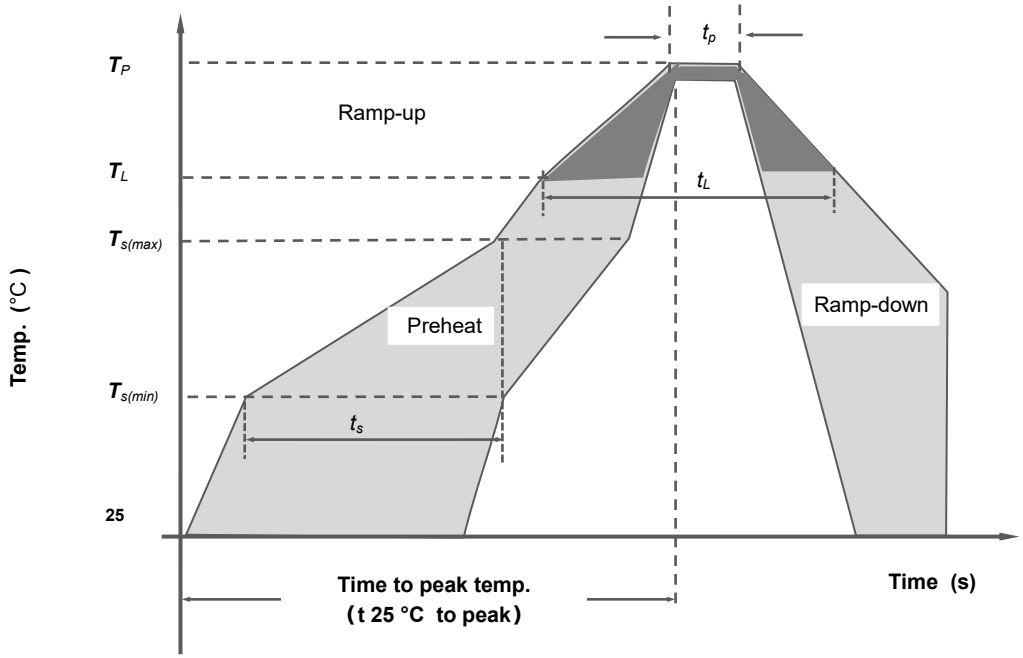
Reflow Soldering Parameters (For Reference Only)



Reflow Condition		Pb-Free Assembly
Preheat	Temp. Min $T_{s(min)}$	150 °C
	Temp. Max $T_{s(max)}$	200 °C
	Time (Min to Max) t_s	(60 to 180) s
Average ramp up rate (Liquidus Temp. (T_L) to peak)		3 °C / second max
$T_{s\ (max)}$ to T_L Ramp-up Rate		5 °C / second max
Reflow	Temp. (T_L) (Liquidus)	217 °C
	Temp. (t_L)	(60 to 150) s
Peak Temp. (T_P)		(255 to 260) °C
Time within 5 °C of actual peak Temp. (t_P)		(10 to 30) s
Ramp-down Rate		6 °C / second max
Time 25 °C to peak Temp. (T_P)		8 minutes max
Do not exceed		260 °C

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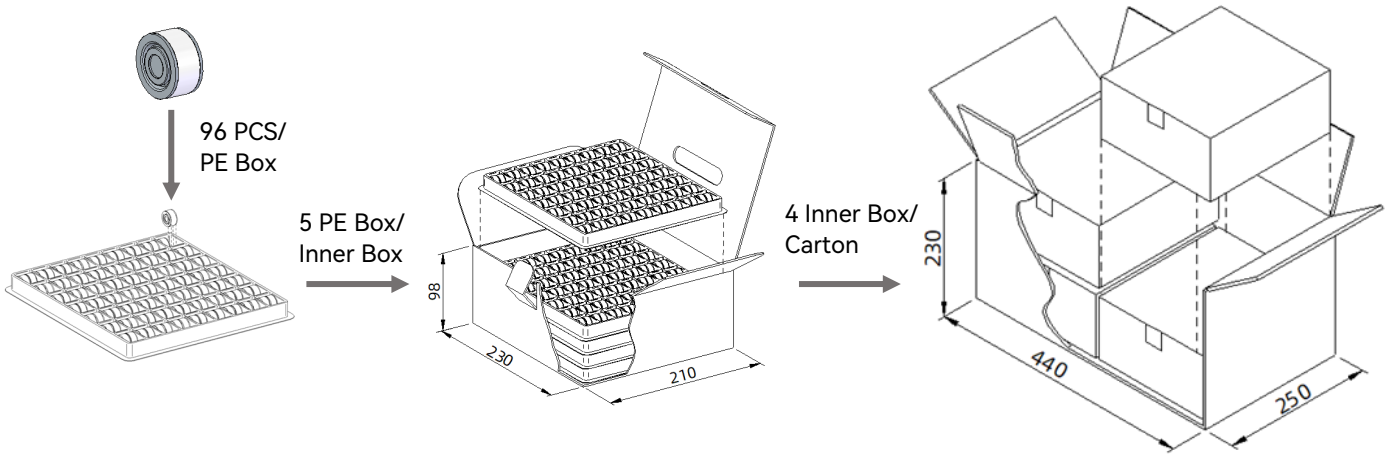
Packaging Information

PE Box Package

Item	PE Box	Inner Box	Carton
Dimensions (mm)	225 × 205 × 16	230 × 210 × 98	440 × 250 × 250
Quantity (PCS)	96	480	1920
Notes: Packaging dimensions and quantity are for reference only.			



The above picture packaging is only suitable for type A products. For the other appearance and packaging mode and quantity, please refer to the specification.

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Glossary

Item	Description
V_s	**D.C.Spark-over Voltage** The voltage at which the GDT sparks over with slowly increasing d.c. voltage. — (IEC 61643-311)
V	**Impulse Spark-over Voltage** The highest Voltage which appears across the terminals of a GDT in the period between the application of an impulse of given wave-shape and the time when current begins to flow. — (ITU-T K.12)
V_a	**Arc Voltage** Voltage drop across the GDT during arc current flow. — (IEC 61643-311)
V_{gl}	**Glow Voltage** The peak value of the voltage drop across the GDT when a glow-current is flowing, It is sometimes called the glow mode voltage. — (ITU-T K.12)
8/20 μs	**8/20 Current Impulse** Current impulse with a nominal virtual front time of 8 μs and a nominal time to half-value of 20 μs. — (IEC 61643-11)
10/350 μs	**10/350 Current Impulse** Current impulse with a nominal virtual front time of 10 μs and a nominal time to half-value of 350 μs. — (IEC 61643-11)
1.2/50 μs	**1.2/50 Voltage Impulse** Voltage impulse with a nominal virtual front time of 1.2 μs and a nominal time to half-value of 50 μs. — (IEC 61643-11)
I	**Alternating Discharge Current** The r.m.s. value of an approximately sinusoidal alternating current passing through the gas discharge tube. — (ITU-T K.12)
I_n	**Nominal Discharge Current** Crest value of the current through the GDT having a current waveshape of 8/20 μs. — (IEC 61643-11)
I_{max}	**Maximum Discharge Current** Crest value of a current through the GDT having an 8/20 μs waveshape and magnitude according to the manufacturers specification. I_{max} is equal to or greater than I_n. — (IEC 61643-11)

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I_{imp}	**Impulse Discharge Current** Crest value of a discharge current through the SPD with specified charge transfer Q and specified energy W/R in the specified time. — (IEC 61643-11)
U_p	**Voltage Protection Level** Maximum voltage to be expected at the SPD terminals due to an impulse stress with defined voltage steepness and an impulse stress with a discharge current with given amplitude and waveshape. — (GB 18802.11、IEC 61643-11)
U_C	**maximum r.m.s. voltage** Which may be continuously applied to the SPD's mode of protection. — (IEC 61643-11)
I_f	**follow current** Peak current supplied by the electrical power system and flowing through the SPD after a discharge current impulse. — (IEC 61643-11)
class I	**class I tests** Tests carried out with the impulse discharge current Iimp, with an 8/20 current impulse with a crest value equal to the crest value of Iimp, and with a 1.2/50 voltage impulse. — (IEC 61643-11)
class II	**class II tests** Tests carried out with the nominal discharge current I_n, and the 1.2/50μs voltage impulse. — (IEC 61643-11)

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ATTENTION

Usage

1. Do not operate GDT in power supply networks, whose maximum operation voltage exceeds the minimum spark-overvoltage of the GDT.
2. The GDT may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
3. If the contacts of GDT are defective, current load can cause sparks and loud noises.
4. When air pressure is from 55 kPa to 106 kPa. The relative altitude shall be +5000 m to –500 m.

Replacement

The GDT is a non-repairable product. For safety sake, please use equivalent GDT for replacement.

Storage

The packaged GDT should be placed in a dry, ventilation and non-corrosive environment.

Installation Position

Do not install the GDT in a touchable position.

Mechanical Stress

Do not take violent action such as knocking when assembling, to avoid product failure.

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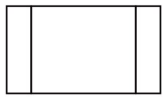
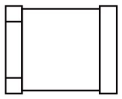
Gas Discharge Tube (GDT) Features & Model List Overview

DC Spark-over Voltage (V) \ Model									
4500	○	○	○	○	○	○	○	○	SE (-SMD)
4000	○	○	○	○	○	○	○	○	SE (-SMD)
3600	○	○	○	○	○	○	○	○	SE (-SMD)
3000	○	○	○	○	○	○	○	○	SE (-SMD)
2500	○	○	○	○	○	○	○	○	SE (-SMD)
2000	○	○	○	○	○	○	○	○	SE (-SMD)
1500	○	○	○	○	○	○	○	○	SE (-SMD)
1200	○	○	○	○	○	○	○	○	SE (-SMD)
1000	○	○	○	○	○	○	○	○	SE (-SMD)
800	○	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
600	○	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
470	○	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
420	○	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
400	SZ (-SMD)	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	○	○	○	○
350	○	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
300	SZ (-SMD)	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	○	○	○	○
250	○	○	○	○	○	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
230	SZ (-SMD)	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
200	SZ (-SMD)	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	○	○	○	○
150	SZ (-SMD)	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
90	SZ (-SMD)	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	SU (-SMD)	SS (-SMD)	SD (-SMD)	SE (-SMD)
75	○	SW (-SMD)	SX (-SMD)	SY (-SMD)	SN (-SMD)	○	SS (-SMD)	SD (-SMD)	SE (-SMD)
70	○	○	○	○	SN (-SMD)	○	SS (-SMD)	SD (-SMD)	SE (-SMD)
Size (mm)	3.2 × 1.6 × 1.6	3.2 × 2.5 × 2.5	4.5 × 3.2 × 2.7	4.0 x 3.5 x 3.5	4.2 × 5.0 × 5.0	5.0 × 5.4 × 5.4	4.2 x 6.2 × 6.2	5.0 × 5.4 × 5.4	6.0 × 8.3 × 8.3
I_n (8/20 μs) (kA) Impulse Discharge Current	0.5	1	1 / 2	3	5	5 / 10	5	5	5 / 10 / 20
Product Structure									
	SMD								

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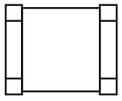
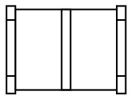
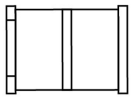
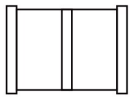
Gas Discharge Tube (GDT) Features & Model List Overview

DC Spark-over Voltage (V) \ Model							
4500	○	○	SF (-SMD)	○	○	○	○
4000	○	○	SF (-SMD)	○	○	○	○
3600	○	○	SF (-SMD)	○	○	○	○
3000	○	○	SF (-SMD)	○	○	○	○
2500	○	○	SF (-SMD)	○	○	○	○
2000	○	○	SF (-SMD)	○	○	○	○
1500	○	○	SF (-SMD)	○	○	○	○
1200	○	○	SF (-SMD)	○	○	○	○
1000	SK (-SMD)	○	SF (-SMD)	○	○	○	○
800	SK (-SMD)	SC (-SMD)	SF (-SMD)	○	○	○	○
600	SK (-SMD)	SC (-SMD)	SF (-SMD)	TS (-SMD)	TZ (-SMD)	TY (-SMD)	TR (-SMD)
470	○	SC (-SMD)	SF (-SMD)	TS (-SMD)	TZ (-SMD)	○	TR (-SMD)
420	SK (-SMD)	SC (-SMD)	SF (-SMD)	TS (-SMD)	TZ (-SMD)	TY (-SMD)	TR (-SMD)
400	○	○	○	○	○	○	○
350	SK (-SMD)	SC (-SMD)	SF (-SMD)	○	TZ (-SMD)	TY (-SMD)	TR (-SMD)
300	○	○	○	TS (-SMD)	○	○	○
250	○	SC (-SMD)	SF (-SMD)	○	○	TY (-SMD)	○
230	○	SC (-SMD)	SF (-SMD)	TS (-SMD)	TZ (-SMD)	TY (-SMD)	TR (-SMD)
200	○	○	○	TS (-SMD)	TZ (-SMD)	○	○
150	○	SC (-SMD)	SF (-SMD)	TS (-SMD)	TZ (-SMD)	○	TR (-SMD)
90	SK (-SMD)	SC (-SMD)	SF (-SMD)	TS (-SMD)	TZ (-SMD)	○	TR (-SMD)
75	○	SC (-SMD)	SF (-SMD)	○	TZ (-SMD)	○	○
70	○	SC (-SMD)	SF (-SMD)	○	○	○	○
Size (mm)	Φ8.0 × 2.2	6.0 × 8.3 × 8.3	6.0 × 6.0 × 6.0	6.8 x 3.5 x 3.5	7.6 × 5.0 × 5.0	7.8 x 5.0 x 5.0	10.0 x 8.3 x 8.3
I_n (8/20 μs) (kA) Impulse Discharge Current	10 / 20	20	3 / 5 / 10	3	5 / 10	5	10 / 20
Product Structure							
				SMD			

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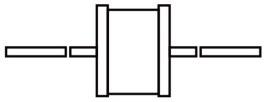
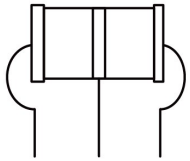
Gas Discharge Tube (GDT) Features & Model List Overview

DC Spark-over Voltage (V) \ Model						
4500	○	SF (-L)	SE (-L)	○	○	○
4000	○	SF (-L)	SE (-L)	○	○	○
3600	○	SF (-L)	SE (-L)	○	○	○
3000	○	SF (-L)	SE (-L)	○	○	○
2500	○	SF (-L)	SE (-L)	○	○	○
2000	○	SF (-L)	SE (-L)	○	○	○
1500	○	SF (-L)	SE (-L)	○	○	○
1200	○	○	SE (-L)	○	○	○
1000	○	SF (-L)	SE (-L)	○	○	○
800	SD (-L)	SF (-L)	SE (-L)	○	○	○
600	SD (-L)	SF (-L)	SE (-L)	TZ (-L)	TB (-L)	TR (-L)
470	SD (-L)	SF (-L)	SE (-L)	TZ (-L)	TB (-L)	TR (-L)
420	SD (-L)	SF (-L)	SE (-L)	TZ (-L)	TB (-L)	TR (-L)
400	○	○	○	○	○	○
350	SD (-L)	SF (-L)	SE (-L)	TZ (-L)	TB (-L)	TR (-L)
300	○	○	○	○	○	○
250	SD (-L)	SF (-L)	SE (-L)	○	○	○
230	SD (-L)	SF (-L)	SE (-L)	TZ (-L)	TB (-L)	TR (-L)
200	○	○	○	TZ (-L)	○	○
150	SD (-L)	SF (-L)	SE (-L)	TZ (-L)	TB (-L)	TR (-L)
90	SD (-L)	SF (-L)	SE (-L)	TZ (-L)	TB (-L)	TR (-L)
75	SD (-L)	SF (-L)	SE (-L)	TZ (-L)	○	○
70	SD (-L)	SF (-L)	SE (-L)	○	○	○
Size (mm)	Φ5.0 × 5.0	Φ5.5 × 6.0	Φ8.0 × 6.0	Φ5.0 × 7.6	Φ6.0 × 8.2	Φ8.0 × 10.0
I_n (8/20 μs) (kA) Impulse Discharge Current	5	3 / 5 / 10	5 / 10 / 20	5 / 10	10	10 / 20
Product Structure						
			DIP			

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Gas Discharge Tube (GDT) Features & Model List Overview

DC Spark-over Voltage (V) \ Model														
4500	○	○	○	○	○	○	○	○	○	○	○	○	○	○
4000	○	○	○	○	○	○	○	○	○	○	○	○	○	○
3600	○	○	○	○	○	○	○	○	○	○	○	○	○	○
3000	○	○	○	○	○	○	○	○	SPR	○	○	○	○	○
2500	○	○	○	○	○	○	○	○	○	○	○	○	○	○
2000	○	SPB	○	○	○	○	○	○	SPR	○	○	○	○	○
1500	SPA	SPB	○	SPJ	SPI	○	○	○	○	○	○	○	○	○
1400	○	○	○	○	○	○	○	○	○	○	○	○	○	TPA
1000	○	SPB	SPC	SPJ	○	○	○	○	○	○	○	○	○	○
800	SPA	SPB	SPC	SPJ	SPI	SPH	SPK	SPP	SPR	SPS	SPV	SPZ	SPO	TPA
600	SPA	SPB	SPC	SPJ	SPI	SPH	SPK	SPP	SPR	SPS	SPV	SPZ	SPO	○
470	○	○	○	○	○	○	○	○	○	○	○	○	○	○
420	○	○	○	○	○	○	○	○	○	○	○	○	○	○
400	○	○	○	○	○	○	○	○	○	○	○	○	○	○
350	SPA	SPB	SPC	SPJ	SPI	SPH	○	○	○	○	SPV	SPZ	○	○
300	○	○	○	○	○	○	○	○	○	○	○	○	○	○
250	○	○	○	○	○	○	○	○	○	○	○	○	○	○
230	○	○	○	○	○	○	○	○	○	○	○	○	○	○
200	○	○	○	○	○	○	○	○	○	○	○	○	○	○
150	○	SPB	○	○	○	○	○	○	○	○	○	○	○	○
90	○	SPB	○	○	○	○	SPK	○	○	○	○	○	○	○
75	○	○	○	○	○	○	○	○	○	○	○	○	○	○
70	○	○	○	○	○	○	○	○	○	○	○	○	○	○
Size (mm)	Φ11.8 × 16.0	Φ11.8 × 6.2	Φ11.8 × 4.2	Φ16.0 × 4.5	Φ16.0 × 8.0	Φ18.0 × 6.7	Φ15.0 × 3.0	Φ30.0 × 12.0	Φ20.0 × 6.0	Φ24.0 × 10.0	Φ20.0 × 4.0	Φ11.8 × 12.0	Φ30.0 × 30.0	16 × 8.4 × 9.3
I_n (8/20 μs) (kA) Impulse Discharge Current	20 / 30 / 40	20		20 / 30	20 / 30 / 40	30	40	25 / 50 / 100	20 / 40	80	40	20 / 40	100	20
Product Structure														

High Current
(May increase each kind of connect mode according to the customer different demand.)

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